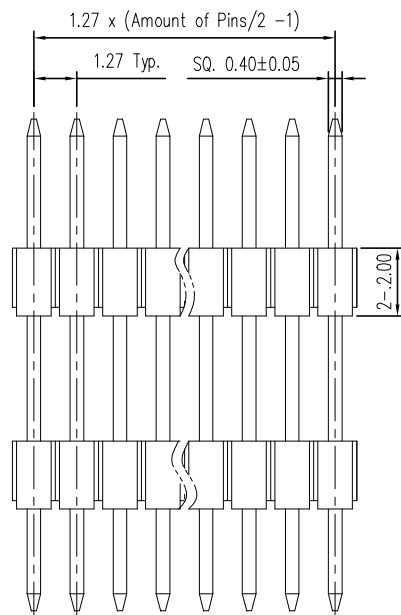
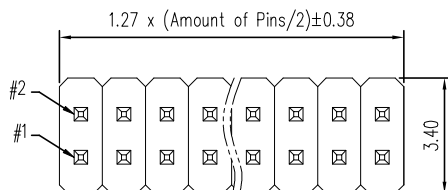
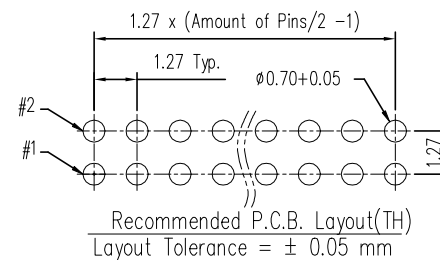


NOTE:

1. MATERIAL,
HOUSING: HIGH TEMP THERMAL PLASTIC, UL94-V0
TERMINAL: COPPER ALLOY
 2. FINISH:
TERMINAL: 40u" MIN Ni UNDER PLATING
 3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1517
 4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION.
 5. MATING SIDE LENGTH: 2.5MM MIN.
 6. PRODUCT NUMBERING:
20021822 - XXX XX X X LF
- LEAD FREE
- PLATING:
0: 80~200u" TIN ALL OVER
1: GOLD FLASH ALL OVER
4: 10u" GOLD AT CONTACT, G/F ON THE OTHER AREA.
8: 30u" GOLD AT CONTACT, G/F ON THE OTHER AREA.
- PACKING
T: TUBE
- PIN COUNT
04, 06, 08, ..., 98, A0
(EVERY EVEN PIN)
- STACK HEIGHT "K"
EXAMPLE: 045=4.5MM
IN 0.5MM INCREMENT



mat'l. code				surface  tolerance		projection 		product family									
				ASME Y14.5		ASME Y14.5		MINITEK 1.27									
ltr	ecn no	dr	date	tolerances unless otherwise specified				title									
B	ELX-N-30567	TONY	2018-06-28	angles	.0±.38			VERTICAL STACK HEADER									
					.00±.25												
				0°±x'	.000±.15												
				dr	STERLING LIN	10'-5-20		dwg no				sheet 1 of 1		size			
				eng	STERLING LIN	10'-5-20		20021822				A4					
				chr	STERLING LIN	10'-5-20											
				app'd	GARY HSIEH	10'-5-20											
sheet index		revision sheet		B	1												